General Description

The GreenMOS® high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS® Z series is integrated with fast recovery diode (FRD) to minimize reverse recovery time. It is suitable for resonant switching topologies to reach higher efficiency, higher reliability and smaller form factor.

Features

- Low $R_{DS(ON)}$ & FOM
- Extremely low switching loss
- Excellent stability and uniformity
- Ultra-fast and robust body diode

Applications

- PC power
- Telecom power
- Server power
- EV Charger
- Motor driver

GreenMOS®

RoHS compliant

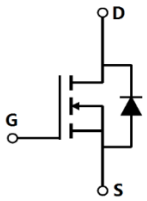
Key Performance Parameters

Parameter	Value	Unit
$V_{DS,\ min}$ @ $T_{j(max)}$	650	V
$I_{D,\ pulse}$	90	A
$R_{DS(ON),\ max}$ @ V_{GS}=10V	108	mΩ
Q_g	37.1	nC

Marking Information

Product Name	Package	Marking
OSG60R108KZF	TO263	OSG60R108KZ

Package & Pin Information



Absolute Maximum Ratings at T_j=25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	600	V
Gate-source voltage	V_{GS}	±30	V
Continuous drain current[1], T_C=25 °C	I_D	30	A
Continuous drain current[1], T_C=100 °C		19	
Pulsed drain current[2], T_C=25 °C	$I_{D, pulse}$	90	A
Continuous diode forward current[1], T_C=25 °C	I_S	30	A
Diode pulsed current[2], T_C=25 °C	$I_{S, pulse}$	90	A
Power dissipation[3], T_C=25 °C	P_D	101	W
Single pulsed avalanche energy[5]	E_{AS}	1000	mJ
MOSFET dv/dt ruggedness, V_{DS}=0…480 V	dv/dt	50	V/ns
Reverse diode dv/dt, V_{DS}=0…480 V, I_{SD}≤I_D	dv/dt	50	V/ns
Operation and storage temperature	T_{stg}, T_j	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-case	$R_{\theta JC}$	1.24	°C/W
Thermal resistance, junction-ambient[4]	$R_{\theta JA}$	62	°C/W

Electrical Characteristics at T_j=25°C unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	BV_{DSS}	600			V	V_{GS}=0 V, I_D=1 mA
		650				V_{GS}=0 V, I_D=1 mA, T_j=150 °C
Gate threshold voltage	$V_{GS(th)}$	3		4.5	V	V_{DS}=V_{GS}, I_D=1 mA
Drain-source on-state resistance	$R_{DS(ON)}$		0.085	0.108	Ω	V_{GS}=10 V, I_D=15 A
			0.2			V_{GS}=10 V, I_D=15 A, T_j=150 °C
Gate-source leakage current	I_{GSS}			100	nA	V_{GS}=30 V
				-100		V_{GS}=-30 V
Drain-source leakage current	I_{DSS}			10	μA	V_{DS}=600 V, V_{GS}=0 V

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Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C_{iss}		2674.5		pF	V_{GS}=0 V, V_{DS}=50 V, f=100 KHz
Output capacitance	C_{oss}		246.0		pF	
Reverse transfer capacitance	C_{rss}		9.6		pF	
Turn-on delay time	$td_{(on)}$		67.4		ns	V_{GS}=10 V, V_{DS}=400 V, R_G=2 Ω, I_D=16 A
Rise time	t_r		71.1		ns	
Turn-off delay time	$t_{d(off)}$		103.9		ns	
Fall time	t_f		33.4		ns	

Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	Q_g		37.1		nC	V_{GS}=10 V, V_{DS}=400 V, I_D=16 A
Gate-source charge	Q_{gs}		11.0		nC	
Gate-drain charge	Q_{gd}		13.8		nC	
Gate plateau voltage	$V_{plateau}$		6.7		V	

Body Diode Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Diode forward voltage	V_{SD}			1.4	V	I_S=30 A, V_{GS}=0 V
Reverse recovery time	t_{rr}		123		ns	I_S=16 A, di/dt=100 A/μs
Reverse recovery charge	Q_{rr}		0.73		uC	
Peak reverse recovery current	I_{rrm}		11		A	

Note

1) Calculated continuous current based on maximum allowable junction temperature.
2) Repetitive rating; pulse width limited by max. junction temperature.
3) Pd is based on max. junction temperature, using junction-case thermal resistance.
4) The value of $R_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_a=25 °C.
5) V_{DD}=100 V, V_{GS}=10 V, L=80 mH, starting T_j=25 °C.

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Electrical Characteristics Diagrams

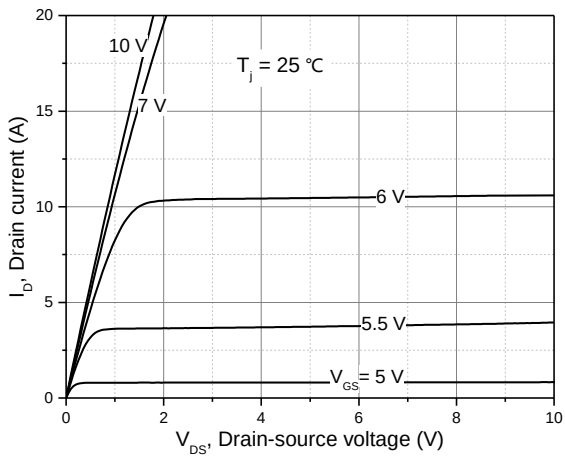

Figure 1. Typ. output characteristics

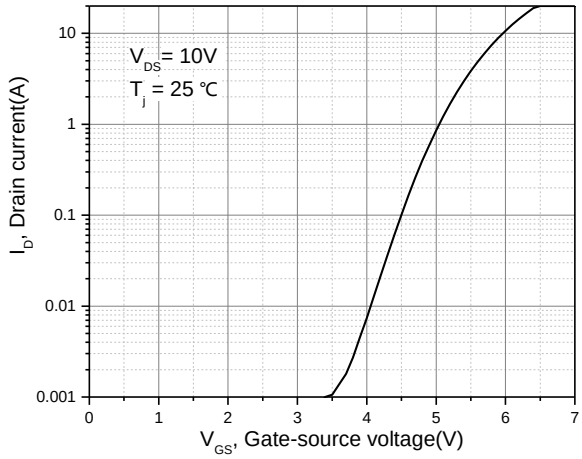

Figure 2. Typ. transfer characteristics

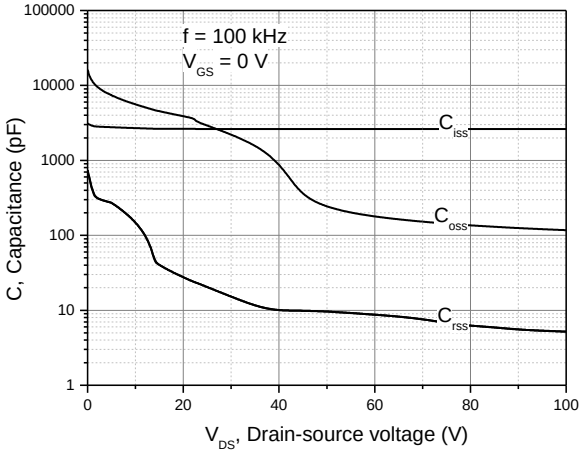

Figure 3. Typ. capacitances

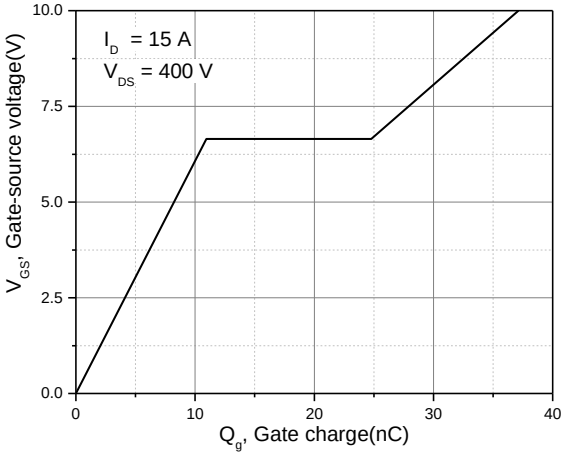

Figure 4. Typ. gate charge

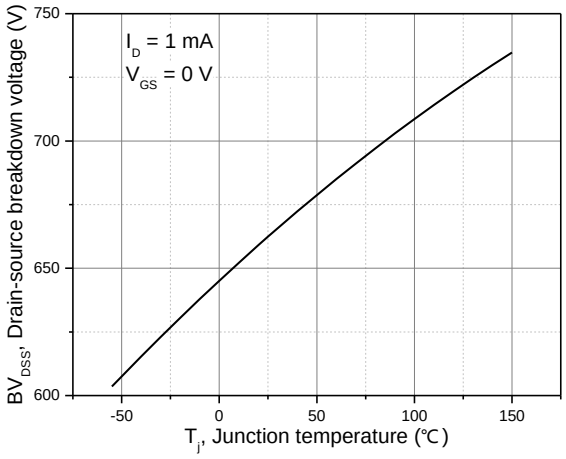

Figure 5. Drain-source breakdown voltage

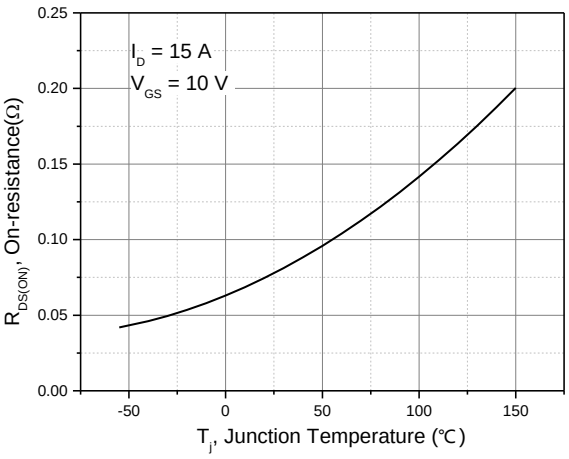

Figure 6. Drain-source on-state resistance

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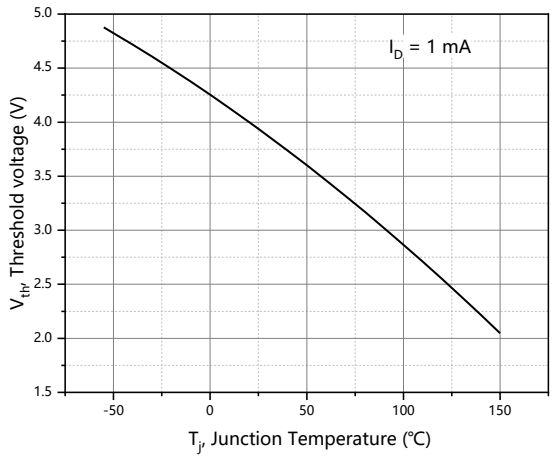


Figure 7. Threshold voltage

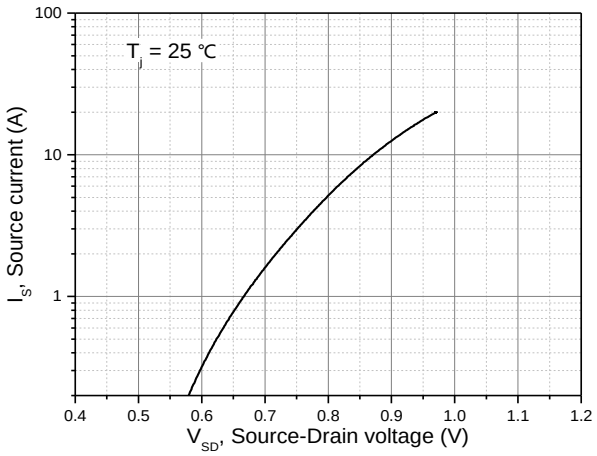


Figure 8. Forward characteristic of body diode

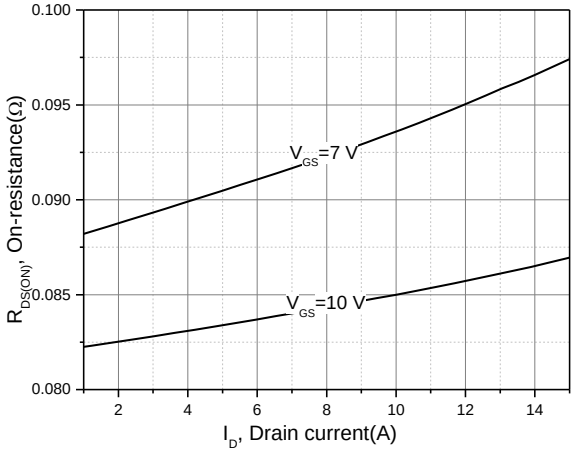


Figure 9. Drain-source on-state resistance

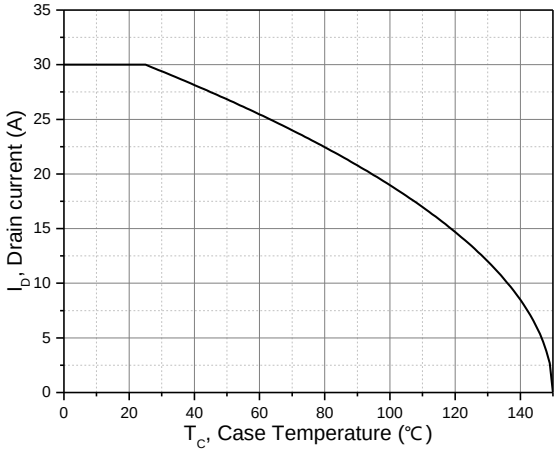


Figure 10. Drain current

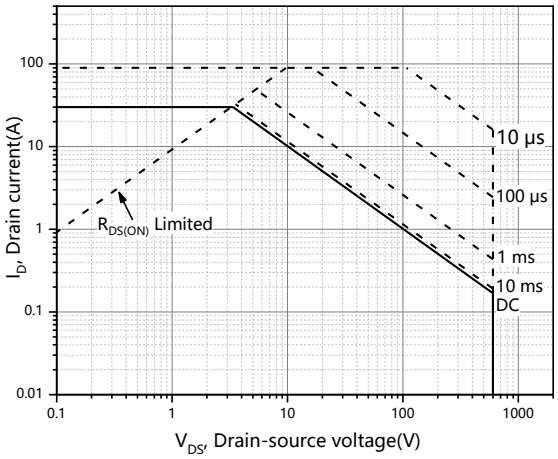


Figure 10. Safe operation area T_C=25 °C

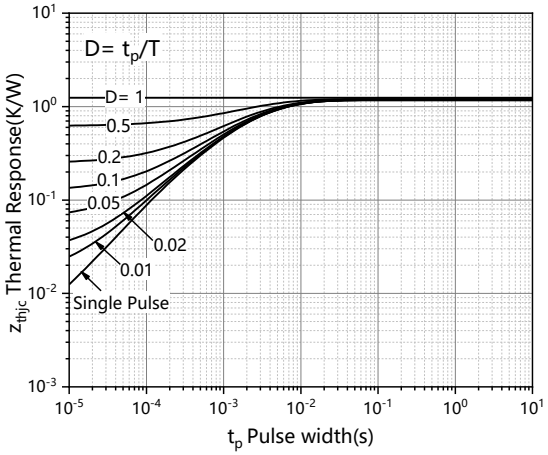


Figure 12, Max. transient thermal impedance

Test circuits and waveforms

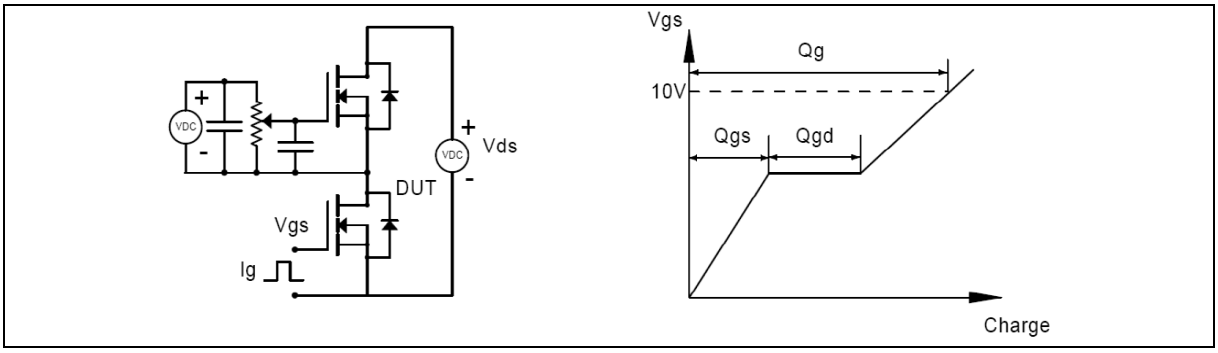


Figure 1. Gate charge test circuit & waveform

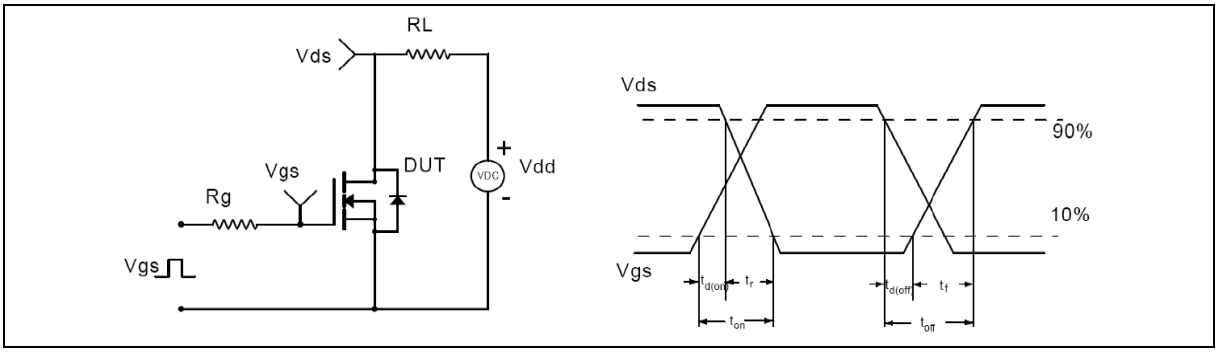


Figure 2. Switching time test circuit & waveforms

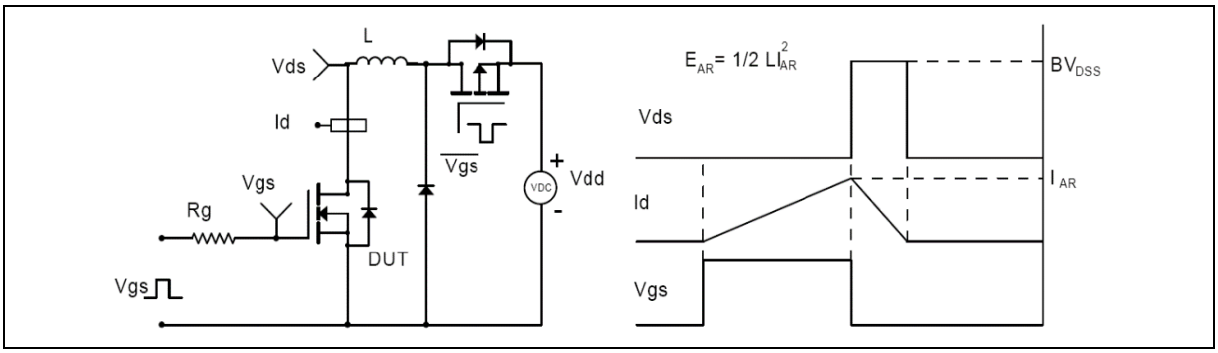


Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms

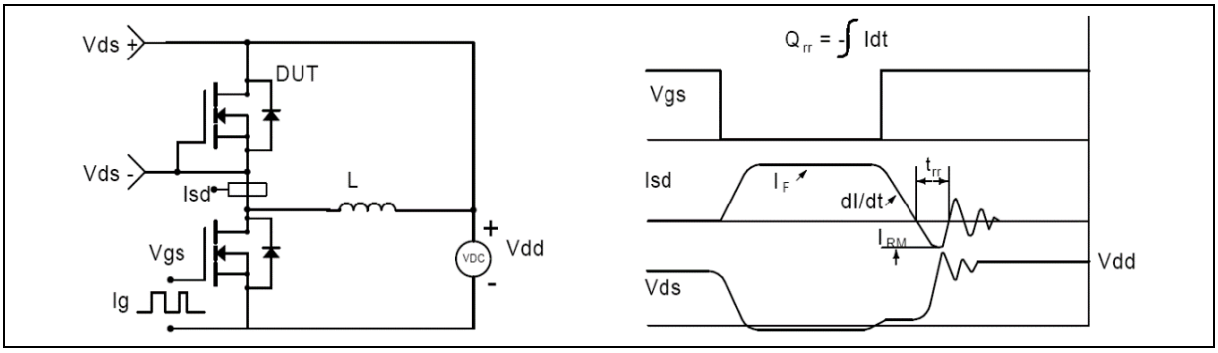
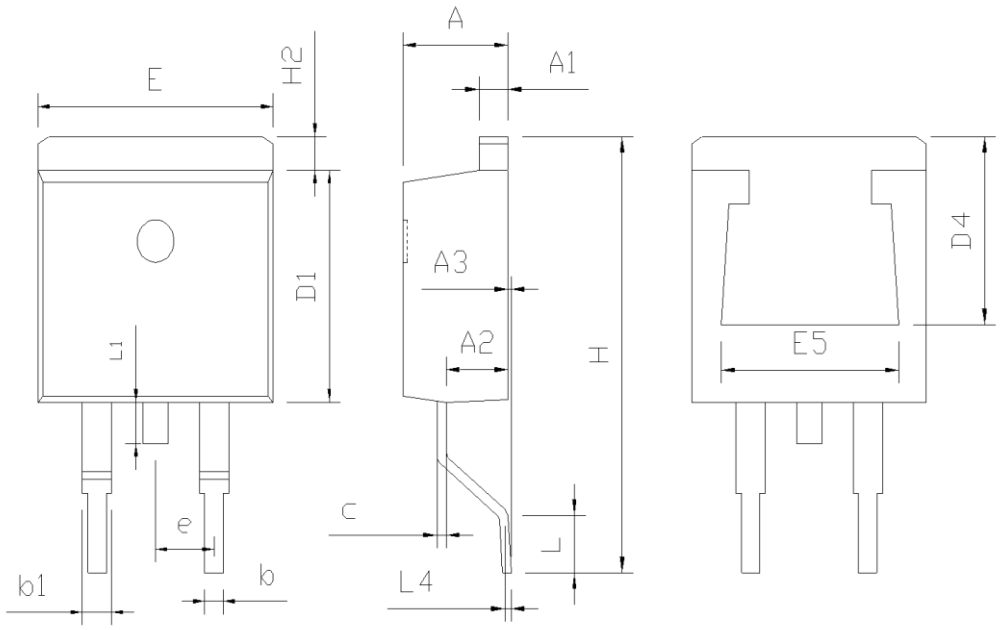


Figure 4. Diode reverse recovery test circuit & waveforms

Package Information



Symbol	mm		
	Min	Nom	Max
A	4.37	4.57	4.77
A1	1.22	1.27	1.42
A2	2.49	2.69	2.89
A3	0.00	0.13	0.25
b	0.70	0.81	0.96
b1	1.17	1.27	1.47
c	0.30	0.38	0.53
D1	8.50	8.70	8.90
D4	6.60	-	-
E	9.86	10.16	10.36
E5	7.06	-	-
e	2.54 BSC		
H	14.70	15.10	15.50
H2	1.07	1.27	1.47
L	2.00	2.30	2.60
L1	1.40	1.55	1.70
L4	0.25 BSC		
θ	0°	5°	9°

Version 1: TO263-P outline dimension

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Ordering Information

Package Type	Units/ Reel	Reels / Inner Box	Units/ Inner Box	Inner Boxes/ Carton Box	Units/ Carton Box
TO263-P	800	1	800	5	4000

Product Information

Product	Package	Pb Free	RoHS	Halogen Free
OSG60R108KZF	TO263	yes	yes	yes

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